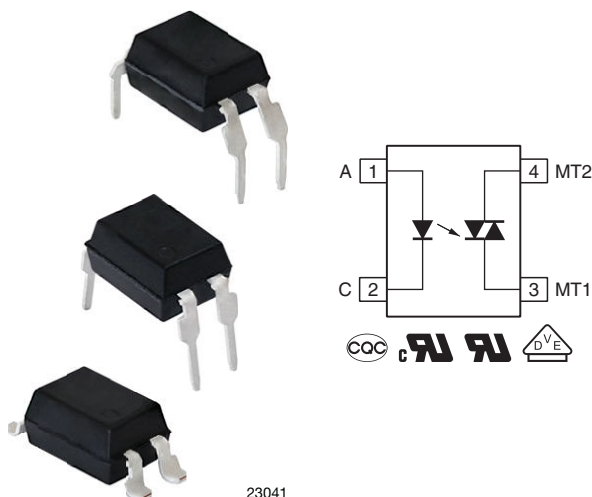




## Optocoupler, Phototriac Output, Non-Zero Crossing, High dV/dt, Low Input Current, DIP-4 Package



23041

### DESIGN SUPPORT TOOLS

**3D**  
Models  
Available

**Design Tools**  
Available

**Related Documents**

[click logo to get started](#)

### DESCRIPTION

The VOT8121A consists of a GaAs IRLED optically coupled to a photosensitive TRIAC packaged in a board space saving DIP-4 package.

The VOT8121A isolates low-voltage logic from 120 V<sub>AC</sub>, 240 V<sub>AC</sub>, and 380 V<sub>AC</sub> lines to control resistive, inductive, or capacitive loads including motors, solenoids, high current thyristors or TRIAC and relays.

### FEATURES

- Space saving package
- High static dV/dt 1000 V/μs
- High input sensitivity I<sub>FT</sub> = 10 mA
- 100 mA on-state current
- 800 V peak off-state blocking voltage
- Isolation rated voltage 5300 V<sub>RMS</sub>
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### APPLICATIONS

- Power TRIAC driver in solid-state relays
- 3-phase AC equipment
- Motor control
- Industrial control
- White goods / household equipment

### AGENCY APPROVALS

- [UL 1577](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884-5\)](#), available with option "V"
- [CQC](#)

### ORDERING INFORMATION

V	O	T	8	1	2	1	A	#	-	V	T	#
PART NUMBER								PACKAGE OPTION		VDE OPTION	TAPE AND REEL	

AGENCY CERTIFIED/PACKAGE	TRIGGER CURRENT, I <sub>FT</sub> (mA)
<b>UL, cUL</b>	<b>10</b>
DIP-4	VOT8121AD
DIP-4, 400 mil	VOT8121AG
SMD-4	VOT8121AB-T <sup>(1)</sup>
SMD-4, 90° orientation	VOT8121AB-T1
SMD-4, 180° orientation	VOT8121AB-T2
SMD-4, 270° orientation	VOT8121AB-T3
<b>VDE, UL, cUL</b>	<b>10</b>
DIP-4	VOT8121AD-V
DIP-4, 400 mil	VOT8121AG-V
SMD-4	VOT8121AB-VT <sup>(1)</sup>
SMD-4, 90° orientation	VOT8121AB-VT1
SMD-4, 180° orientation	VOT8121AB-VT2
SMD-4, 270° orientation	VOT8121AB-VT3

#### Note

<sup>(1)</sup> Also available in tubes; do not add T to end



<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
Reverse voltage		$V_R$	6	V
Forward current		$I_F$	50	mA
Power dissipation		$P_{diss}$	120	mW
Junction temperature		$T_j$	125	$^{\circ}\text{C}$
<b>OUTPUT</b>				
Peak off-state voltage		$V_{DRM}$	800	V
Power dissipation		$P_{out}$	300	mW
On-state current		$I_{T(RMS)}$	100	mA
Peak repetitive surge current	PW = 100 $\mu\text{s}$ , 120 pps	$V_{TSM}$	1	A
Junction temperature		$T_j$	125	$^{\circ}\text{C}$
<b>COUPLER</b>				
Storage temperature range		$T_{stg}$	-55 to +125	$^{\circ}\text{C}$
Ambient temperature range		$T_{amb}$	-55 to +110	$^{\circ}\text{C}$
Total power dissipation		$P_{diss}$	330	mW
Soldering temperature	For 10 s	$T_{sld}$	260	$^{\circ}\text{C}$

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.  
This phototriac should not be used to drive a load directly. It is intended to be a trigger device only

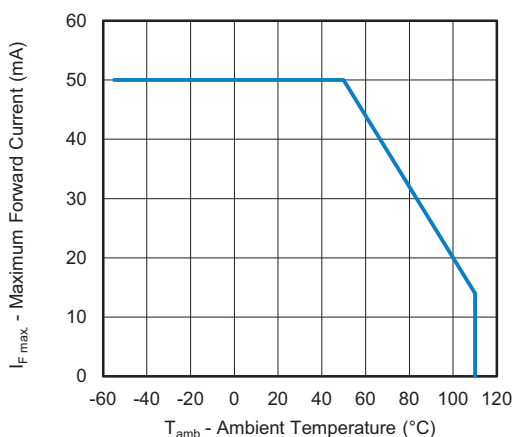


Fig. 1 - Maximum Forward Current vs. Ambient Temperature

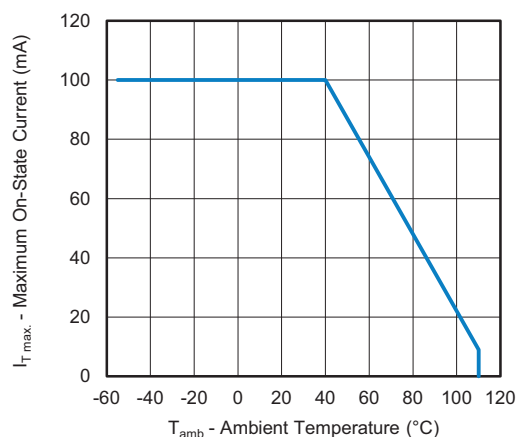


Fig. 2 - Maximum On-State Current vs. Ambient Temperature



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>						
Forward voltage	$I_F = 20\text{ mA}$	$V_F$	-	1.2	1.4	V
Reverse current	$V_R = 3\text{ V}$	$I_R$	-	-	10	$\mu\text{A}$
<b>OUTPUT</b>						
Off-state current	$V_{DRM} = 800\text{ V}$	$I_{DRM}$	-	-	1	$\mu\text{A}$
On-state voltage	$I_T = 100\text{ mA peak}$	$V_{TM}$	-	-	3	V
Holding current		$I_H$	-	400	-	$\mu\text{A}$
Critical rate of rise of off-state voltage		$dV/dt^{(1)}$	1000	-	-	V/ $\mu\text{s}$
<b>COUPLER</b>						
Trigger current	$V_{TM} = 3\text{ V}$	$I_{FT}$	-	-	10	mA

**Notes**

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

<sup>(1)</sup> Static  $dV/dt$

<b>SAFETY AND INSULATION RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 110 / 21	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL 1577, $t = 1\text{ min}$	$V_{ISO}$	5300	$V_{RMS}$
Maximum transient isolation voltage	According to DIN EN 60747-5-5	$V_{IOTM}$	8000	$V_{peak}$
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5, DIP-4, SMD-4	$V_{IORM}$	890	$V_{peak}$
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5, DIP-4, 400 mil	$V_{IORM}$	1140	$V_{peak}$
Isolation resistance	$T_{amb} = 25\text{ }^{\circ}\text{C}$ , $V_{IO} = 500\text{ V}$	$R_{IO}$	$\geq 10^{12}$	$\Omega$
	$T_{amb} = 100\text{ }^{\circ}\text{C}$ , $V_{IO} = 500\text{ V}$	$R_{IO}$	$\geq 10^{11}$	$\Omega$
Output safety power		$P_{SO}$	600	mW
Input safety current		$I_{SI}$	400	mA
Input safety temperature		$T_S$	175	$^{\circ}\text{C}$
Creepage distance	DIP-4, SMD-4		$\geq 7$	mm
Clearance distance			$\geq 7$	mm
Creepage distance	DIP-4, 400 mil		$\geq 8$	mm
Clearance distance			$\geq 8$	mm
Insulation thickness		DTI	$\geq 0.4$	mm

**Note**

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits



## TYPICAL CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

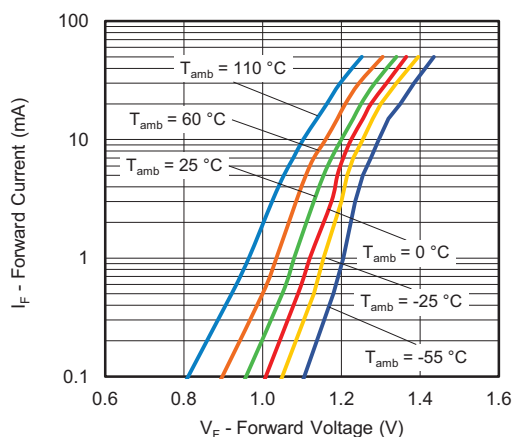


Fig. 3 - Forward Current vs. Forward Voltage

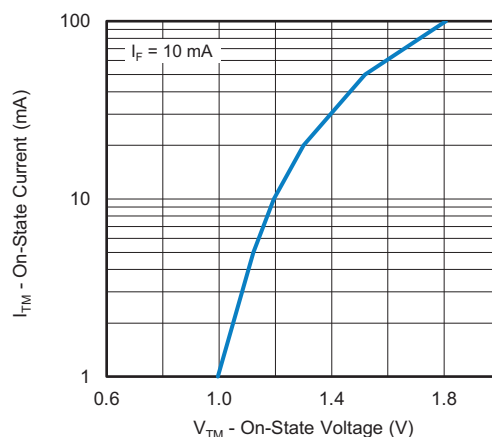


Fig. 6 - On State Current vs. On State Voltage

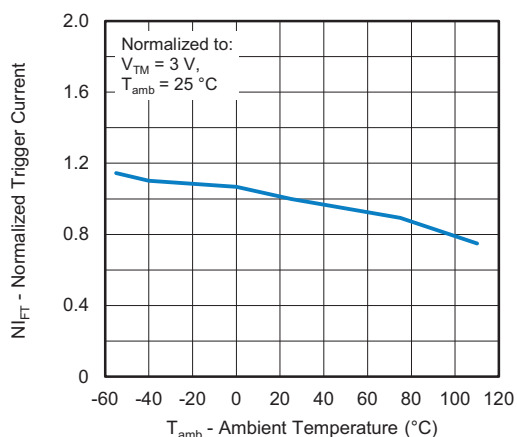


Fig. 4 - Normalized Trigger Current vs. Ambient Temperature

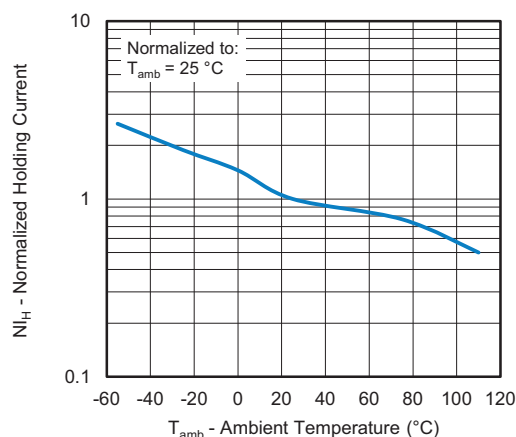


Fig. 7 - Normalized Holding Current vs. Ambient Temperature

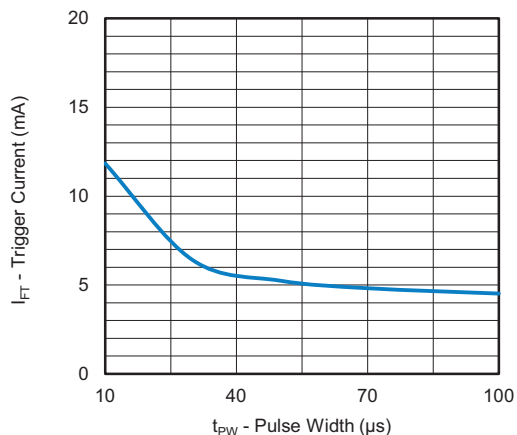


Fig. 5 - Trigger Current vs. Pulse Width

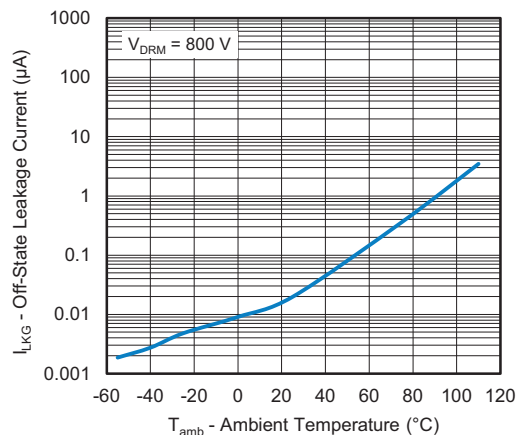


Fig. 8 - Off-State Leakage Current vs. Ambient Temperature

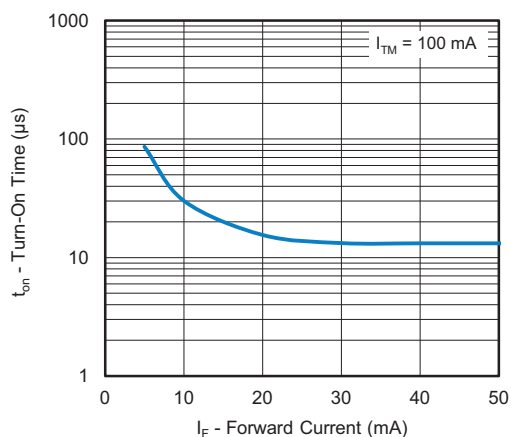


Fig. 9 - Turn-On Time vs. Forward Current

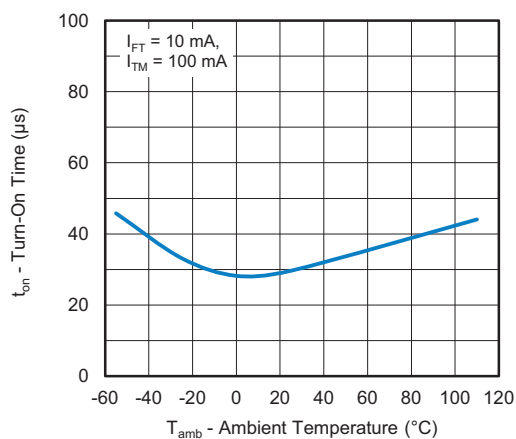


Fig. 10 - Turn-On Time vs. Ambient Temperature

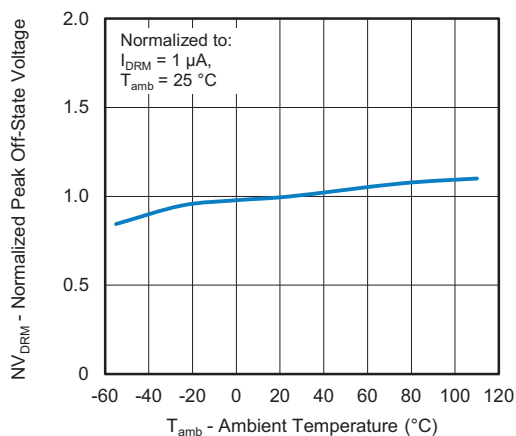


Fig. 11 - Normalized Peak Off-State Voltage vs. Ambient Temperature



## PACKAGE DIMENSIONS (in millimeters)

### DIP-4

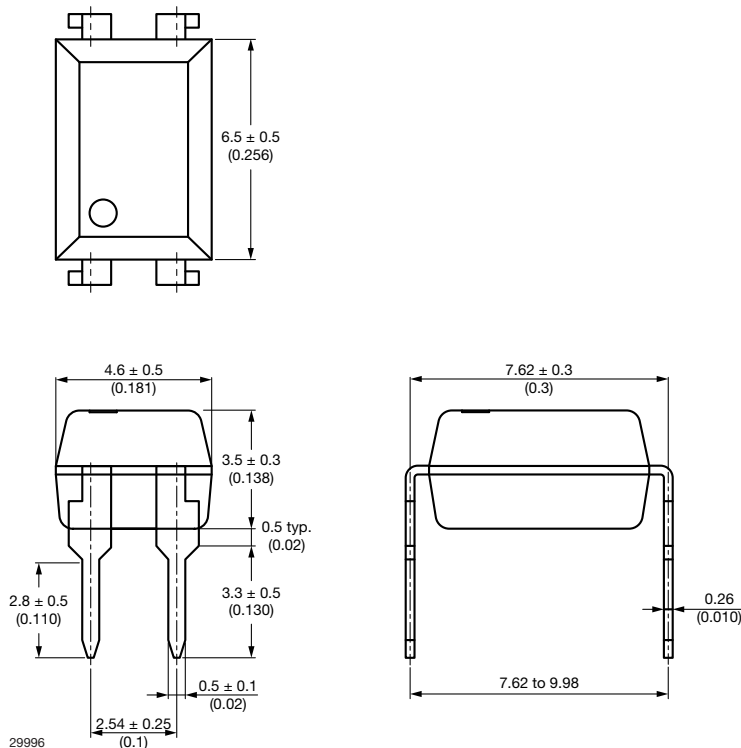


Fig. 1

### DIP-4, 400 mil

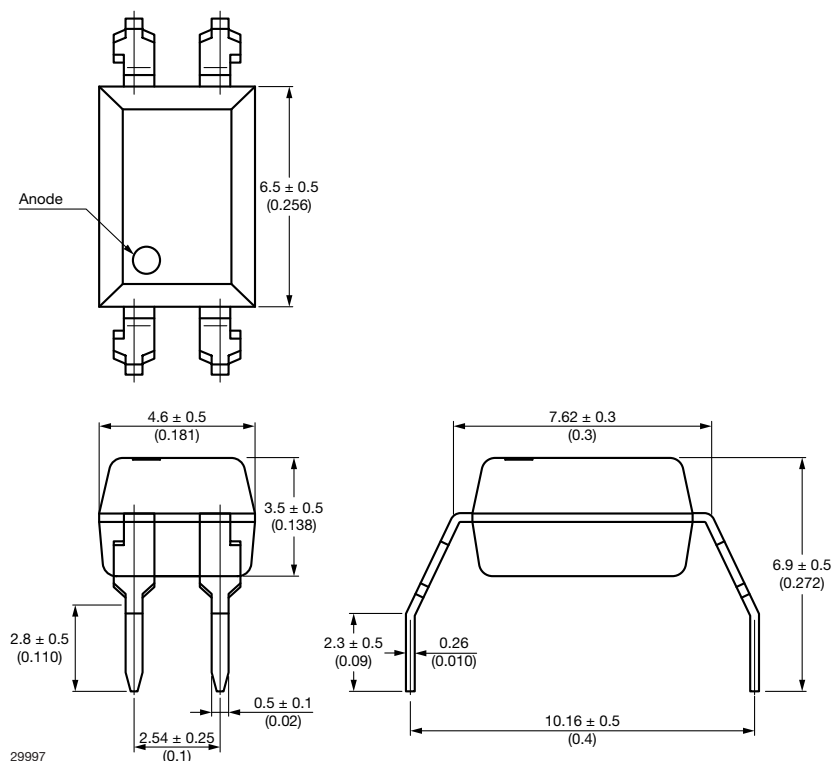


Fig. 2



## SMD-4

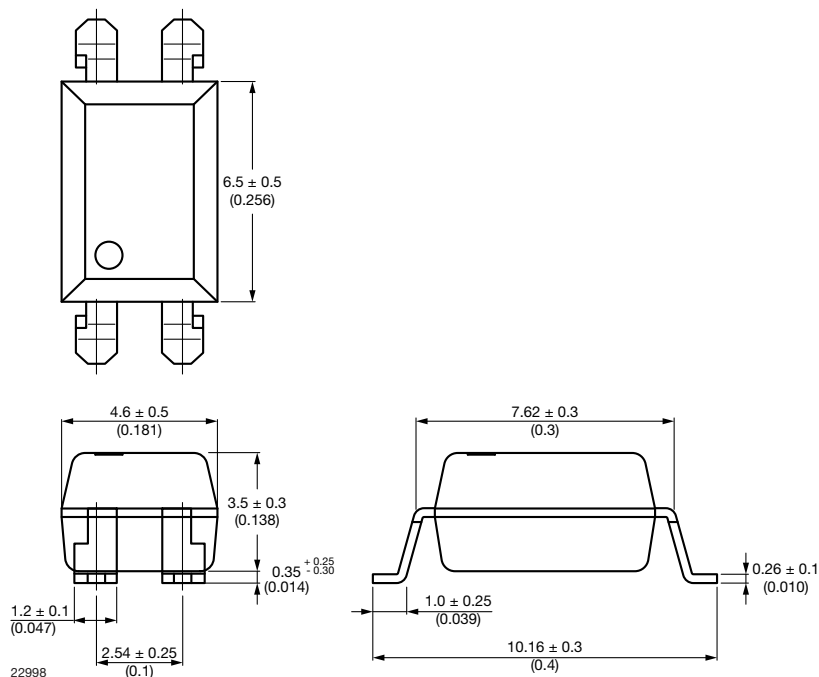


Fig. 3

## PACKAGE MARKING



Fig. 12 - Example of VOT8121AD-VT

### Notes

- “YWW” is the date code marking (Y = year code, WW = week code)
- VDE logo is only marked on VDE option parts
- Tape and reel suffix (T) is not part of the package marking


**PACKAGING INFORMATION** (in millimeters)

DEVICES PER TUBE			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
DIP-4	100	40	4000
DIP-4, 400 mil	100	40	4000
SMD-4	100	40	4000

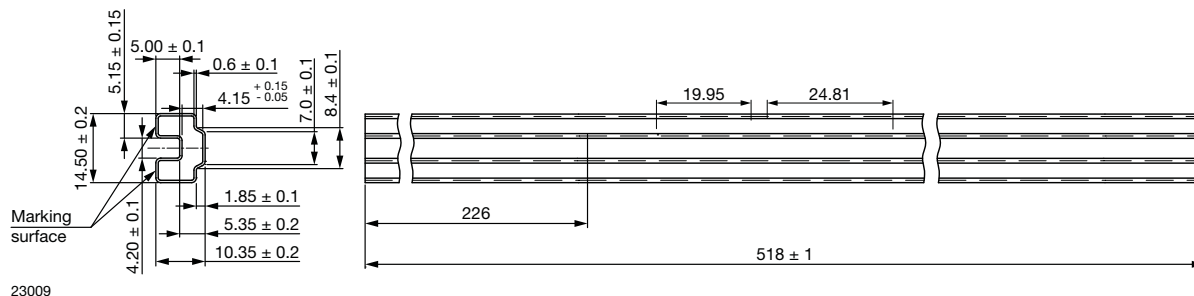
**DIP-4 Tube**


Fig. 13 - Tube

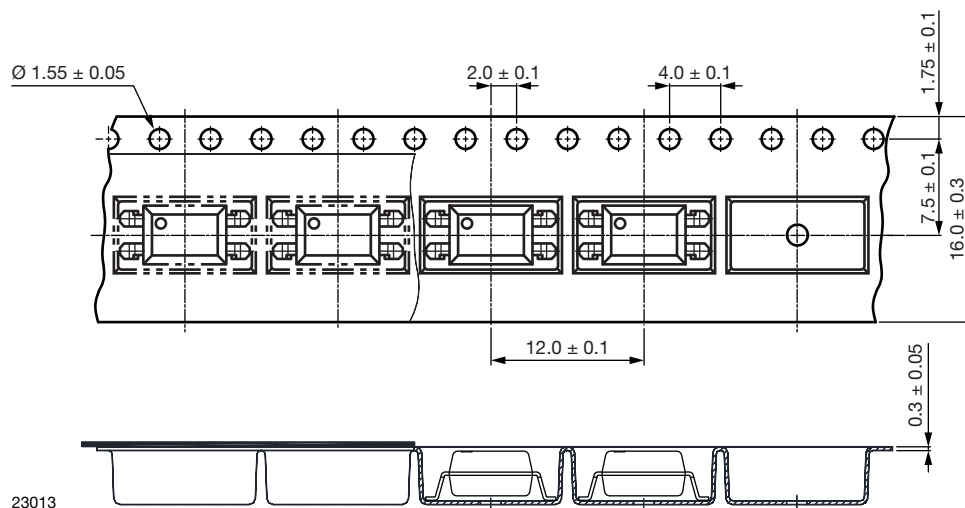
**SMD-4 Tape**


Fig. 14 - Tape and Reel Packaging (1000 pieces on reel)





## SMD-4 Tape, 90° Orientation

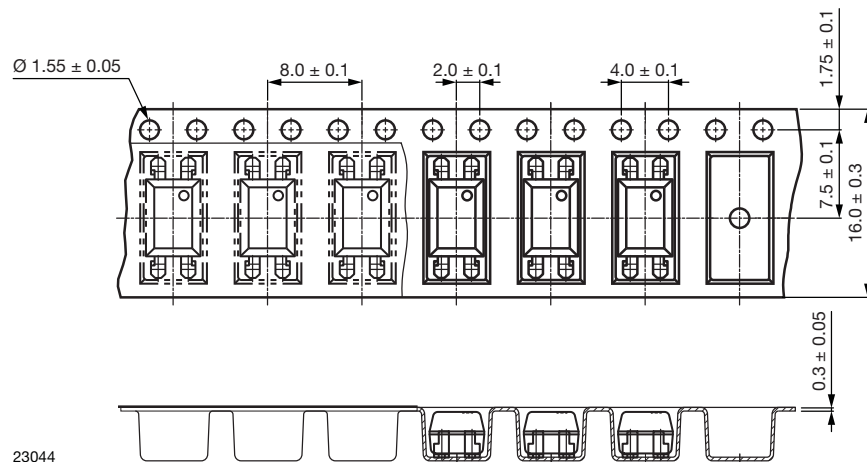


Fig. 15 - Tape and Reel Packaging (2000 pieces on reel)

## SMD-4 Tape, 180° Orientation

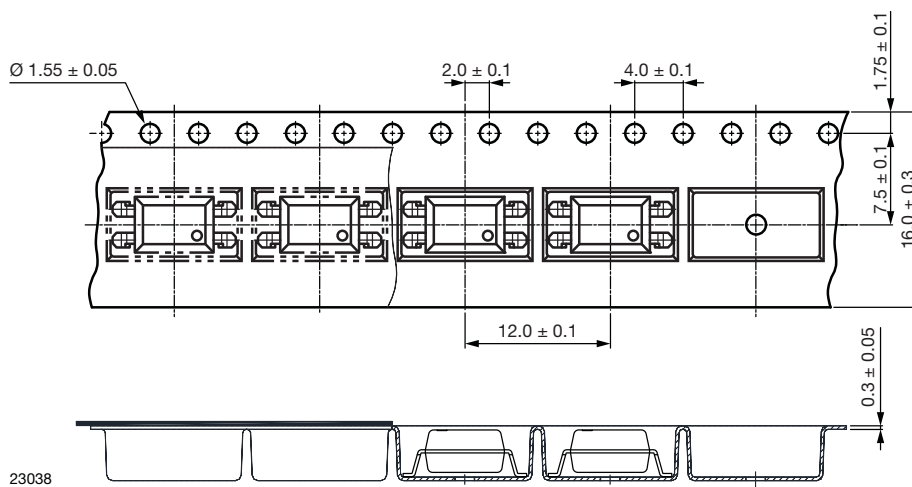


Fig. 16 - Tape and Reel Packaging (1000 pieces on reel)

## SMD-4 Tape, 270° Orientation

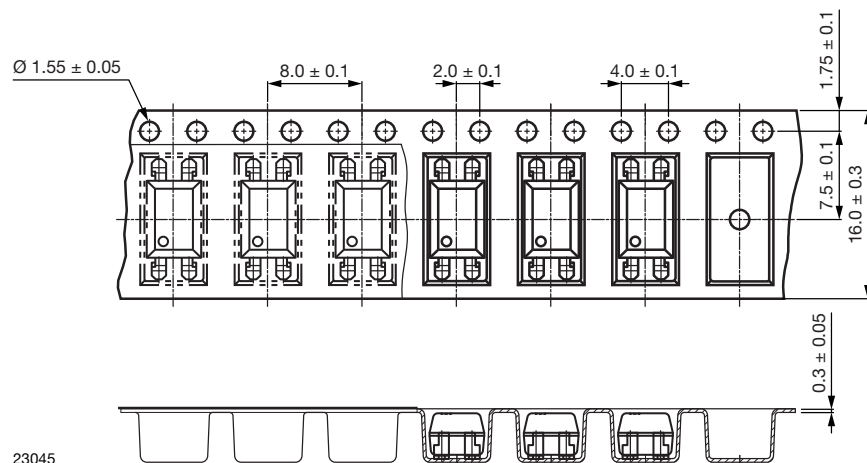


Fig. 17 - Tape and Reel Packaging (2000 pieces on reel)



Reel

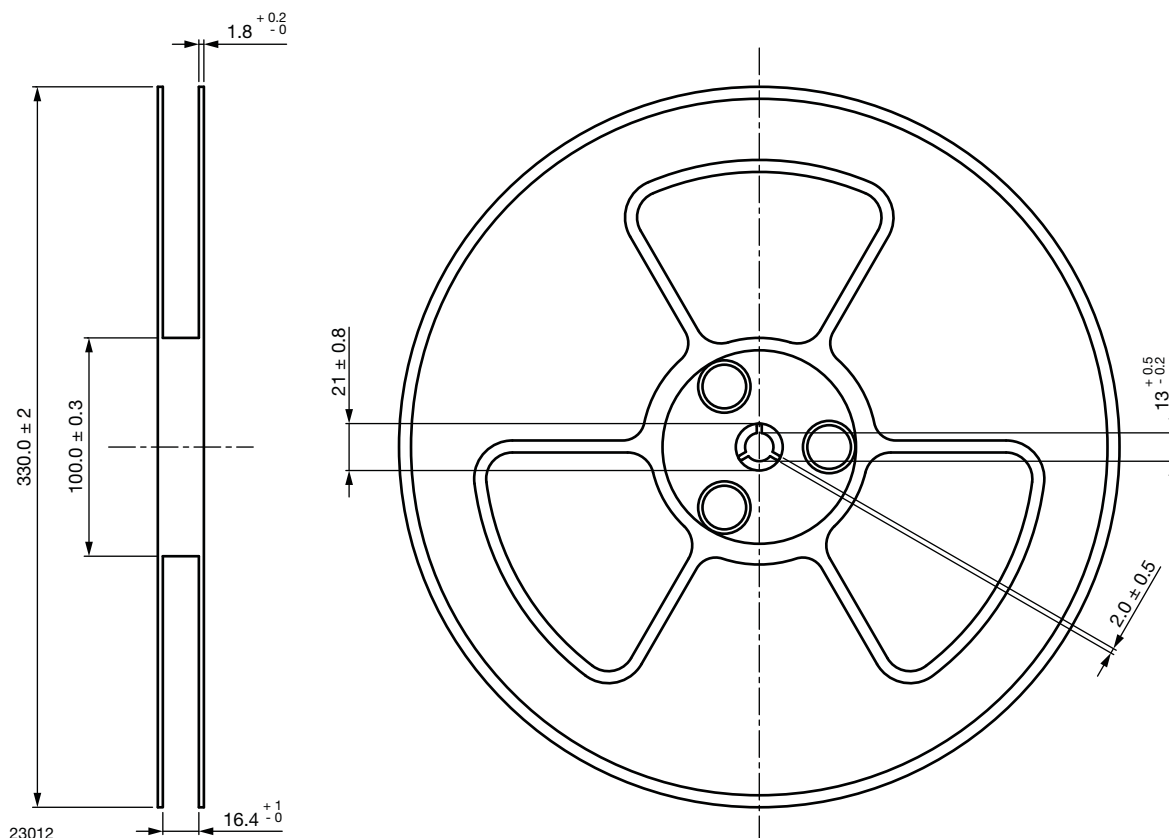


Fig. 18 - Tape and Reel Shipping Medium

**SOLDER PROFILES****IR Reflow Soldering (JEDEC® J-STD-020C compliant)**

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

PROFILE ITEM	CONDITIONS
Preheat	
- Temperature minimum ( $T_{S \text{ min.}}$ )	150 °C
- Temperature maximum ( $T_{S \text{ max.}}$ )	200 °C
- Time (min. to max.) ( $t_S$ )	90 s $\pm$ 30 s
Soldering zone	
- Temperature ( $T_L$ )	217 °C
- Time ( $t_L$ )	60 s
Peak temperature ( $T_p$ )	260 °C
Ramp-up rate	3 °C/s max.
Ramp-down rate	3 °C/s to 6 °C/s

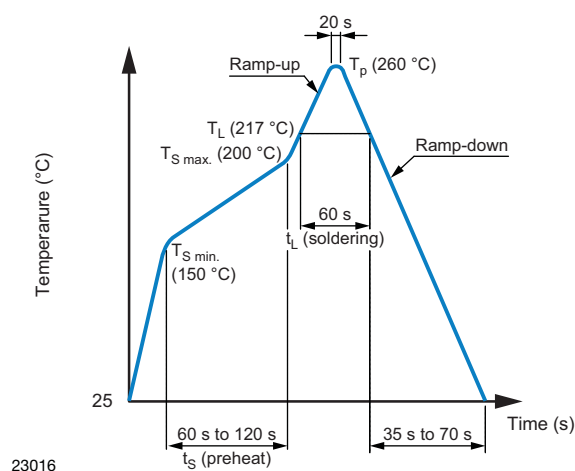


Fig. 4

**Wave Soldering (JEDEC JESD22-A111 compliant)**

One time soldering is recommended within the condition of temperature.

Temperature: 260 °C + 0 °C / - 5 °C

Time: 10 s

Preheat temperature: 25 °C to 140 °C

Preheat time: 30 s to 80 s

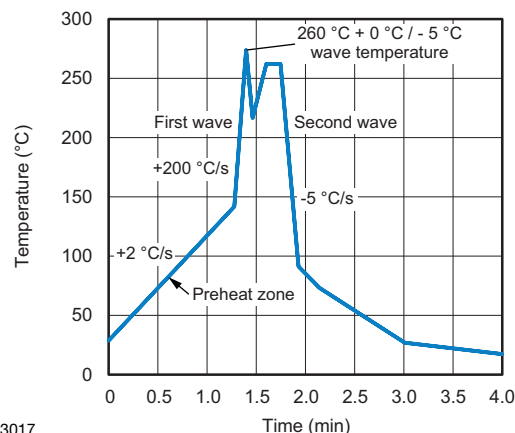


Fig. 5

23017

**Hand Soldering by Soldering Iron**

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380 °C + 0 °C / - 5 °C

Time: 3 s max.

**HANDLING AND STORAGE CONDITIONS**

ESD level: HBM class 2

Floor life: unlimited

Conditions:  $T_{amb} < 30$  °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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